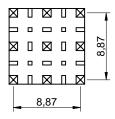
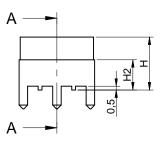
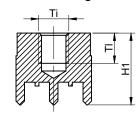
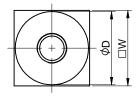
Dimensions: [mm]

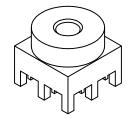


sectional drawing A-A





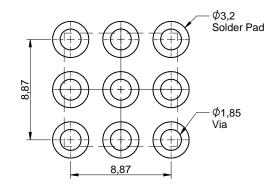




Article Properties:

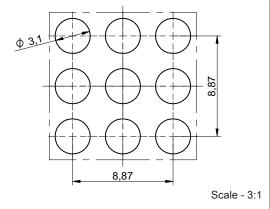
<u> </u>			
Properties		Value	Unit
Height	Н	7	mm
Height	H ₁	9.5	mm
Height	H ₂	4	mm
Width	W	10	mm
Thread Length	T _I	4	mm
Diameter	ØD	9.7	mm
Inner Thread	T _i	M4	

Recommended Land Pattern: [mm]



Scale - 3:1

Stencil Suggestion:



Properties:

Material	Brass	
Surface	Tin	
Tightening Torque	1.2 Nm	
Solder Cream Thickness	150 µm	
Operating Temperature	-55 °C up to +150 °C	
Pins	9	

Electrical Properties:

Properties	Test conditions		Value	Unit
Rated Current	@ 20 °C	I _R	85	A

Packaging Properties:

Packaging	Tape and Reel	
Packaging Unit (Qty.)	400	

ı	Würth Elektronik eiSos GmbH & Co. Ki
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Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0

www.we-online.com eiSos@we-online.com



CREATED	CHECKED	GENERAL TOLERANCE	PROJECTION METHOD		
DaMa	WIW	DIN ISO 2768-1m	METHOD		
				- T	

REDCUBE THR Terminal with blind-hole thread WP-THRBU

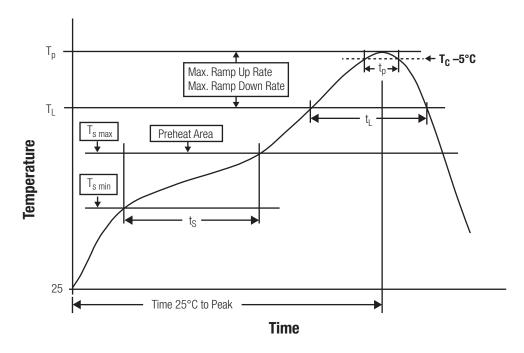
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 2016-10-10
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Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

Profile Feature		Value
Preheat Temperature Min ¹⁾	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time t_s from $T_{s min}$ to $T_{s max}$	t _s	60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	T _L	217 °C
Time t_L maintained above T_L	t _L	60 - 150 seconds
Peak package body temperature	T _p	see table
Time within 5°C of actual peak temperaure	t p	20 - 30 seconds
Ramp-down Rate (T _L to T _P)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

¹⁾ refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E

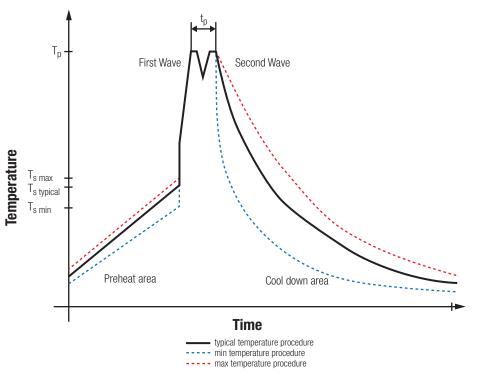
Package Classification Reflow Temperature:

Properties	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000
PB-Free Assembly Package Thickness < 1.6 mm ¹⁾	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly I Package Thickness ≥ 2.5 mm	250 °C	245 °C	245 °C

¹⁾ refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E

CREATED CHECKED GENERAL TOLERANCE Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions DaMa WIW DIN ISO 2768-1m Max-Eyth-Str. 1 74638 Waldenburg **REDCUBE THR Terminal with** Tel. +49 (0) 79 42 945 - 0 blind-hole thread WP-THRBU www.we-online.com 746 501 94R eiSos@we-online.com REVISION STATUS BUSINESS UNIT PAGE 001.000 Valid 2016-10-10 eiCan 2/4 **WÜRTH ELEKTRONIK**

Classification Wave Soldering Profile:



Classification Wave Soldering Profile:

Profile Feature		Pb-Free Assembly	Sn-Pb Assembly	
Preheat Temperature Min ¹⁾	T _{s min}	100 °C	100 °C	
Preheat Temperature Typical	T _{s typical}	120 °C	120 °C	
Preheat Temperature Max	T _{s max}	130 °C	130 °C	
Preheat Time t_s from $T_{s min}$ to $T_{s max}$	t _s	70 seconds	70 seconds	
Ramp-up Rate	ΔΤ	150 °C max.	150 °C max.	
Peak temperature	T _p	250 °C - 260 °C	235 °C - 260 °C	
Time of actual peak temperature	t _p	max. 10 seconds max. 5 seconds each wave	max. 10 seconds max. 5 seconds each wave	
Ramp-down Rate, Min		~ 2 K/ second	~ 2 K/ second	
Ramp-down Rate, Typical		~ 3.5 K/ second	~ 3.5 K/ second	
Ramp-down Rate, Max		~ 5 K/ second	~ 5 K/ second	
Time 25°C to 25°C		4 minutes	4 minutes	

1) refer to EN61760-1:2006 refer to EN61760-1:2006

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GENERAL TOLERANCE CHECKED WIW DIN ISO 2768-1m

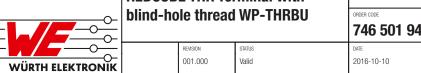
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REDCUBE THR Terminal with blind-hole thread WP-THRBU

746 501 94R

STATUS BUSINESS UNIT eiCan



Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

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8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

